

Result of tenders of RMB Sovereign Bonds held on June 20, 2019

The following is issued on behalf of the Hong Kong Monetary Authority:

Result of the tenders of RMB Sovereign Bonds held on June 20, 2019:

Tender Result

Tender Date : June 20, 2019

Bonds available for Tender : 2-year RMB Bonds

Issue Number : BCMKFB19023

Issue Date : June 24, 2019

Maturity Date : June 24, 2021 (or the closest coupon payment date)

Application Amount : RMB 11,243 million

Issue Amount : RMB 3,500 million

Average accepted Coupon Rate : 2.79 per cent

Highest accepted Coupon Rate
(Bonds' Coupon) : 2.95 per cent

Lowest accepted Coupon Rate : 2.50 per cent

Allocation Ratio : Approximately 1.51 per cent

Tender Result

Tender Date	: June 20, 2019
Bonds available for Tender	: 5-year RMB Bonds
Issue Number	: BCMKFB19024
Issue Date	: June 24, 2019
Maturity Date	: June 24, 2024 (or the closest coupon payment date)
Application Amount	: RMB 4,387 million
Issue Amount	: RMB 1,000 million
Average accepted Coupon Rate	: 2.92 per cent
Highest accepted Coupon Rate (Bonds' Coupon)	: 3.03 per cent
Lowest accepted Coupon Rate	: 2.70 per cent
Allocation Ratio	: Approximately 42.96 per cent